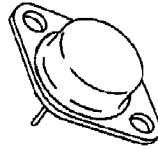


2N6767/2N6768
N-Channel Power MOSFETs,
15 A, 350 V/400 V

Description

These devices are n-channel, enhancement mode, power MOSFETs designed especially for high voltages, high speed applications, such as off-line switching power supplies, UPS, AC and DC motor controls, relay and solenoid drivers.



- V_{GS} Rated at ± 20 V
- Silicon Gate for Fast Switching Speeds
- I_{DSS} , $R_{DS(on)}$ Specified at Elevated Temperature
- Rugged
- Low Drive Requirements
- Ease of Paralleling

2N6767
 2N6768

Maximum Ratings

| Symbol | Characteristic | Rating 2N6768 | Rating 2N6767 | Unit |
|----------------|---|------------------|------------------|--------------------|
| V_{DSS} | Drain to Source Voltage | 400 | 350 | V |
| V_{DGR} | Drain to Gate Voltage $R_{GS} = 1.0 \text{ M}\Omega$ | 400 | 350 | V |
| V_{GS} | Gate to Source Voltage | ± 20 | ± 20 | V |
| T_J, T_{stg} | Operating Junction and Storage Temperatures | -55 to +150 | -55 to +150 | $^{\circ}\text{C}$ |
| T_L | Maximum Lead Temperature for Soldering Purposes, 1/16" From Case for 10 s | 300 | 300 | $^{\circ}\text{C}$ |

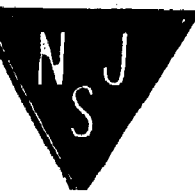
Maximum On-State Characteristics

| | | | | |
|--------------|--|-----------|------------|----------|
| $R_{DS(on)}$ | Static Drain-to-Source On Resistance | 0.3 | 0.4 | Ω |
| I_D | Drain Current Continuous at $T_C = 25^{\circ}\text{C}$ Continuous at $T_C = 100^{\circ}\text{C}$ | 14 9.0 | 12 7.75 | A |
| I_{DM} | Pulsed | 25^2 | 20^2 | |

Maximum Thermal Characteristics

| | | | | |
|-----------------|--|-----------|------------|-----------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 0.83 | 0.83 | $^{\circ}\text{C}/\text{W}$ |
| P_D | Total Power Dissipation at $T_C = 25^{\circ}\text{C}$ at $T_C = 100^{\circ}\text{C}$ | 150 60 | 1.50 60 | W |
| | Linear Derating Factor | 1.2 | 1.2 | W/ $^{\circ}\text{C}$ |

Notes
 All values are JEDEC registered except as noted. For information concerning connection diagram and package outline, refer to Section 7.



2N6767/2N6768

Electrical Characteristics (T_C = 25°C unless otherwise noted)

| Symbol | Characteristic | Min | Max | Unit | Test Conditions |
|--|---|------------------|------------------|-------|---|
| Off Characteristics | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage ¹ 2N6768 2N6767 | 400 ² | | V | V _{GS} = 0 V, I _D = 1.0 mA |
| | | 350 ² | | | |
| I _{DSS} | Zero Gate Voltage Drain Current | | 1 | mA | V _{DS} = Rated V _{DSS} , V _{GS} = 0 V V _{DS} = Rated V _{DSS} , V _{GS} = 0 V, T _C = 125°C |
| | | | 4 | | |
| I _{GSS} | Gate-Body Leakage Current | | ±100 | nA | V _{GS} = ±20 V, V _{DS} = 0 V |
| On Characteristics | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | 2.0 | 4.0 | V | I _D = 1 mA, V _{DS} = V _{GS} |
| R _{DS(on)} | Static Drain-Source On-Resistance 2N6768 2N6767 2N6768 2N6767 | | 0.3 | Ω | V _{GS} = 10 V I _D = 9.0 A I _D = 7.75 A I _D = 9.0 A I _D = 7.75 A |
| | | | 0.4 | | |
| | | | 0.66 | | |
| | | | 0.88 | | |
| V _{DS(on)} | Drain-Source On-Voltage 2N6768 2N6767 | | 5.6 5.4 | V | V _{GS} = 10 V I _D = 14 A I _D = 12 A |
| | | | | | |
| g _{fs} | Forward Transconductance | 8.0 | 24 | S (Ω) | V _{DS} = 15 V, I _D = 9.0 A |
| Dynamic Characteristics | | | | | |
| C _{iss} | Input Capacitance | 1000 | 3000 | pF | V _{DS} = 25 V, V _{GS} = 0 V f = 1.0 MHz |
| C _{oss} | Output Capacitance | 200 | 600 | pF | |
| C _{rss} | Reverse Transfer Capacitance | 50 | 200 | pF | |
| Switching Characteristics (T_C = 25°C, Figures 9, 10) | | | | | |
| t _{d(on)} | Turn-On Delay Time | | 35 | ns | V _{DD} = 180 V, I _D = 9.0 A V _{GS} = 10 V, R _{GEN} = 4.7 Ω R _{GS} = 4.7 Ω |
| t _r | Rise Time | | 65 | ns | |
| t _{d(off)} | Turn-Off Delay Time | | 150 | ns | |
| t _f | Fall Time | | 75 | ns | |
| Q _g | Total Gate Charge | | 120 ² | nC | V _{GS} = 10 V, I _D = 16 A V _{DD} = 400 V |

Electrical Characteristics (Cont.) (T_C = 25°C unless otherwise noted)

| Symbol | Characteristic | Min | Typ | Max | Unit | Test Conditions |
|---|---|------|-------------------|------------------------------------|------|--|
| Source-Drain Diode Characteristics | | | | | | |
| I _S | Continuous Source Current 2N6768 2N6767 | | | 14 12 | A | |
| I _{SM} | Pulsed Source Current 2N6768 2N6767 | | | 25 ² 20 ² | A | |
| V _{SD} | Diode Forward Voltage 2N6768 2N6767 | 0.85 | | 1.7 | V | V _{GS} = 0 V I _S = 14 A I _S = 12 A |
| | | 0.8 | | 1.6 | | |
| t _{rr} | Reverse Recovery Time | | 1000 ² | | ns | V _{GS} = 0 V, T _J = 150°C I _F = I _{SM} , dI _F /dt = 100 A/μs |
| Q _{RR} | Reverse Recovery Charge | | 25 ² | | μC | V _{GS} = 0 V, T _J = 150°C I _F = I _{SM} , dI _F /dt = 100 A/μs |